

SURFACE MOUNT RECTIFIER

REVERSE VOLTAGE: 50 --- 1000 V
CURRENT: 3.0 A

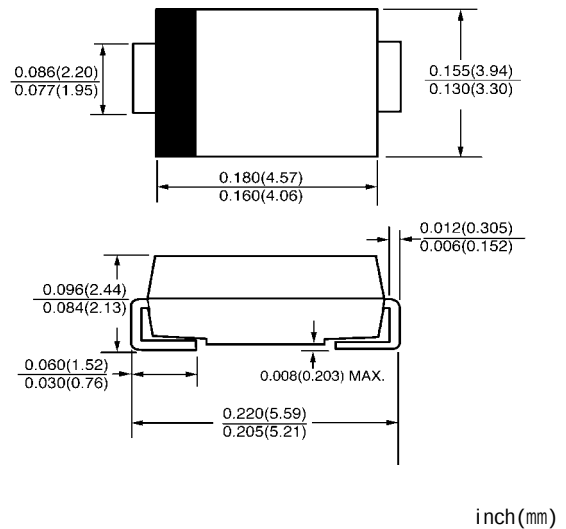
FEATURES

- ◇ Plastic package has underwriters laboratory flammability classification 94V-0
- ◇ For surface mounted applications
- ◇ Low profile package
- ◇ Built-in strain relief, ideal for automated placement
- ◇ Glass passivated chip junction
- ◇ High temperature soldering:
250°C/10 seconds at terminals

MECHANICAL DATA

- ◇ Case: JEDEC DO-214AA, molded plastic over passivated chip
- ◇ Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- ◇ Polarity: Color band denotes cathode end
- ◇ Weight: 0.003 ounces, 0.093 gram

DO - 214AA(SMB)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

		S3AB	S3BB	S3DB	S3GB	S3JB	S3KB	S3MB	UNITS
Device marking code		SAB	SBB	SDB	SGB	SJB	SKB	SMB	
Maximum recurrent peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RWS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current @ T _L =90°C	I _{F(AV)}	3.0							A
Peak forward surge current @ T _L = 110°C 8.3ms single half-sine-wave superimposed on rated load(JEDEC Method)	I _{FSM}	100							A
Maximum Instantaneous forward voltage at 3.0 A	V _F	1.15							V
Maximum DC reverse current @T _A =25°C	I _R	10							μ A
at rated DC blocking voltage @T _A =100°C		100							
Typical junction capacitance	C _J	35							pF
Typical thermal resistance (NOTE 2)	R _{θJA}	40							°C/W
Operating junction and storage temperature range	T _J T _{STG}	-55-----+150							°C

NOTE: 1. Measured at 1.0MHz and applied reverse voltage of 4.0 Volts

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2. Thermal resistance from junction to ambient and junction to lead P.C.B. mounted on 0.27"X0.27"(7.0X7.0mm²) copper pad areas

FIG.1 – FORWARD DERATING CURVE

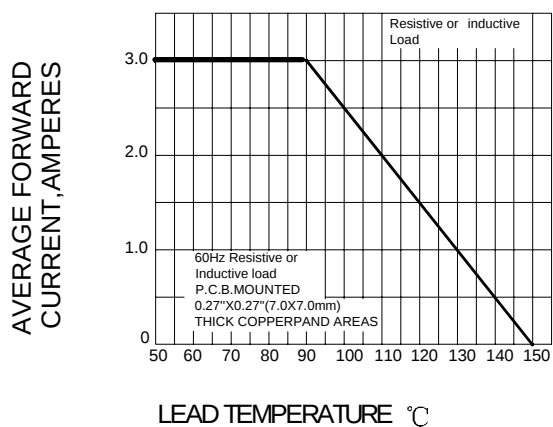


FIG.2 PEAK FORWARD SURGE CURRENT

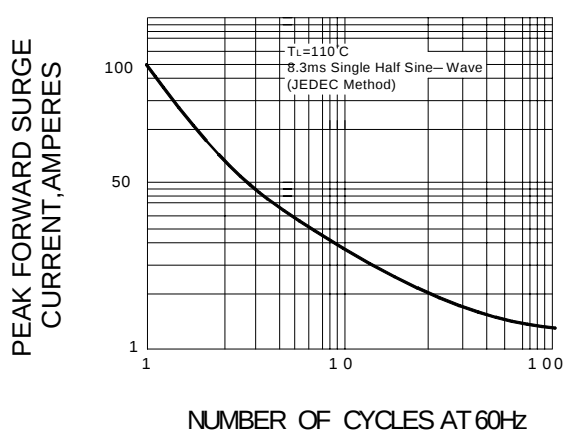


FIG.3 – TYPICAL FORWARD CHARACTERISTICS

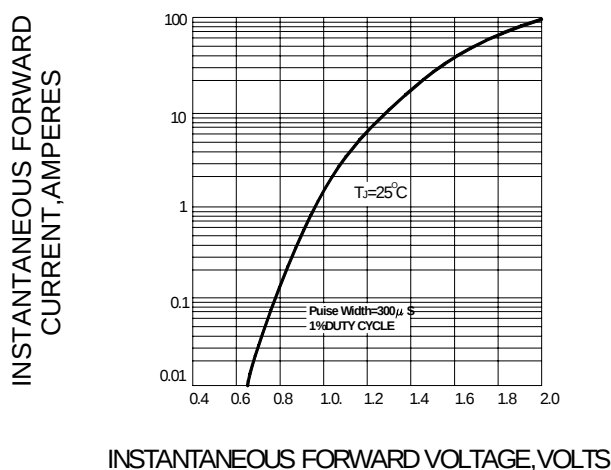


FIG.4 – TYPICAL REVERSE CHARACTERISTICS

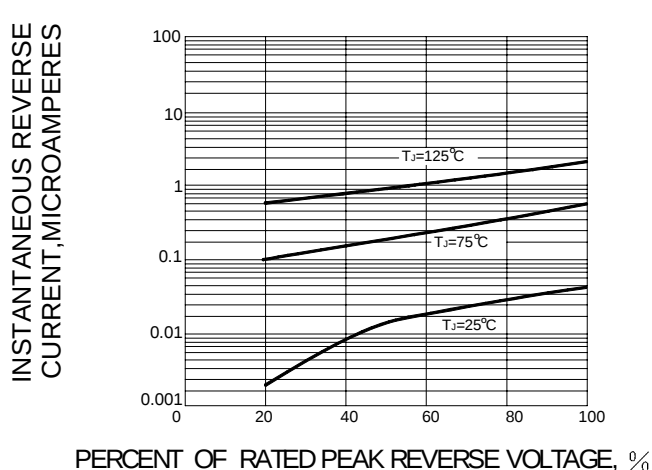


FIG.5-TYPICAL JUNCTION CAPACITANCE

